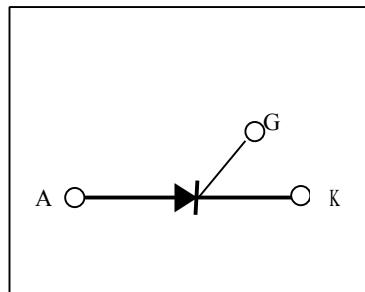
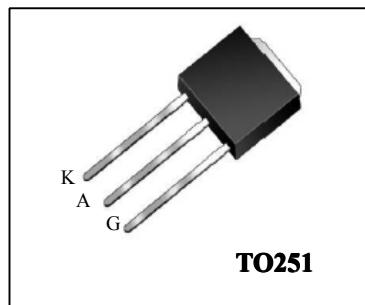


Silicon Controlled Rectifiers
Features

- ◆ Repetitive Peak Off-State Voltage : 600V
- ◆ R.M.S On-State Current ($I_{T(RMS)} = 4 \text{ A}$)
- ◆ Low On-State Voltage (1.6V(Typ.) @ I_{TM})


General Description

Sensitive gate triggering SCR is suitable for the application where requiring high bidirectional blocking voltage capability and also suitable for over voltage protection ,motor control circuit in power tool, inrush current limit circuit and heating control system.


Absolute Maximum Ratings ($T_j = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Condition	Ratings	Units
V_{DRM}	Repetitive Peak Off-State Voltage		600	V
$I_{T(AV)}$	Average On-State Current(180° Conduction Angle)	$T_i = 60^\circ\text{C}$	1.35	A
		$T_{amb}=25^\circ\text{C}$	0.9	
$I_{T(RMS)}$	R.M.S On-State Current(180° Conduction Angle)	$T_i = 60^\circ\text{C}$	4	A
		$T_{amb}=25^\circ\text{C}$	1.35	
I_{TSM}	Surge On-State Current	1/2 Cycle, 60Hz, Sine Wave Non-Repetitive	33	A
I^2t	I^2t for Fusing	$t = 10\text{ms}$	4.5	A^2s
di/dt	Critical rate of rise of on-state current	$F=60\text{Hz}, T_j=125^\circ\text{C}$	50	$\text{A}/\mu\text{s}$
P_{GM}	Forward Peak Gate Power Dissipation		0.5	W
$P_{G(AV)}$	Forward Average Gate Power Dissipation	$T_j=125^\circ\text{C}$	0.2	W
I_{FGM}	Forward Peak Gate Current		1.2A	A
T_j	Operating Junction Temperature		-40-125 $^\circ\text{C}$	$^\circ\text{C}$
T_{STG}	Storage Temperature		-40-150 $^\circ\text{C}$	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance Junction to Case(DC)	15	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance Junction to Ambient(DC)	100	$^\circ\text{C}/\text{W}$

SCU4C60S

Electrical Characteristics ($T_c=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Value			Units
			Min	Typ	Max	
I_{DRM}	Repetitive Peak Off-State Current	$VAK=V_{DRM}$ $RGK=1\text{ k}\Omega$	-	-	5	μA
			-	-	1	mA
V_{TM}	Peak On-State Voltage (1)	$ITM=8\text{ A}$, $tp=380\text{ }\mu\text{s}$	-	-	1.8	V
I_{GT}	Gate Trigger Current (2)	$VD=12\text{ V}$, $RL=140$	20	-	50	μA
V_{GT}	Gate Trigger Voltage (2)		-	-	0.8	V
V_{GD}	Non-Trigger Gate Voltage (1)	$VD=12\text{ V}$, $RL=3.3\text{ k}\Omega$, $RGK=1\text{ k}\Omega$	0.1			V
dv/dt	Critical Rate of Rise Off-State Voltage	$VD=67\%V_{DRM}$, $RGK=1\text{ k}\Omega$	15	-	-	$\text{V}/\mu\text{s}$
I_H	Holding Current	$IT=50\text{ mA}$, $RGK=1\text{ k}\Omega$	-	-	5	mA
I_L	Latching Current	$IT=1\text{ mA}$, $RGK=1\text{ k}\Omega$	6	-	-	mA
R_d	Dynamic resistance	$T_j=125^\circ\text{C}$	-	-	100	$\text{m}\Omega$

Note:

1. Pulse Width = 1.0 ms , Duty cycle $\leq 1\%$

2. R_{GK} Current not Included in measurement

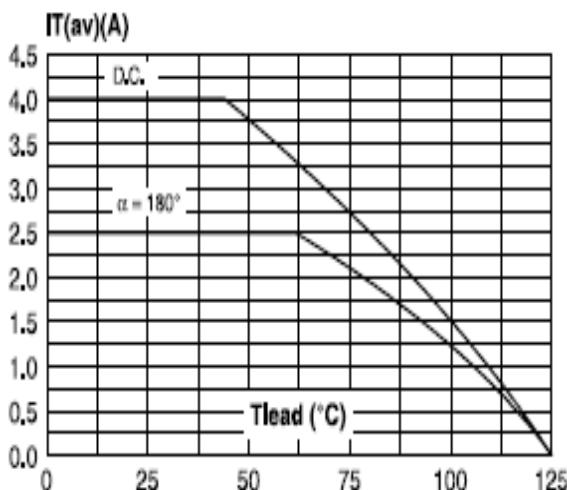


Fig. 1 $I_{T(av)}(DC)$ vs lead Temperature

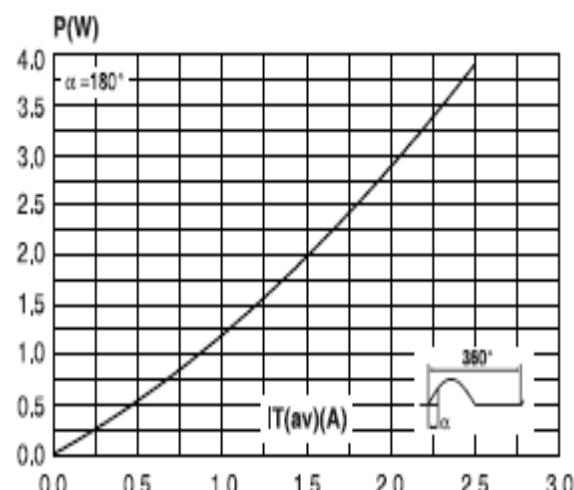


Fig. 2 $P_{D(av)}$ VS $I_{T(av)}$

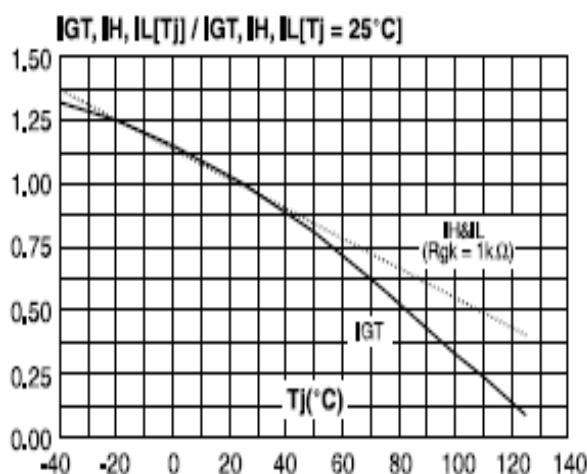


Fig. 3 I_{GT}, I_H, I_L Temperature Characteristics

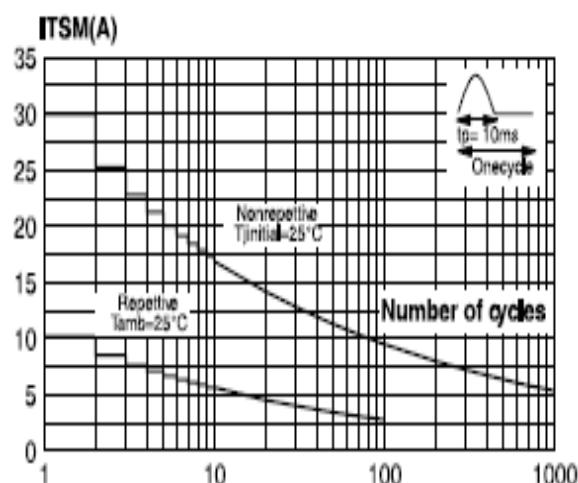


Fig. 4 I_{TSM} VS Number of cycles

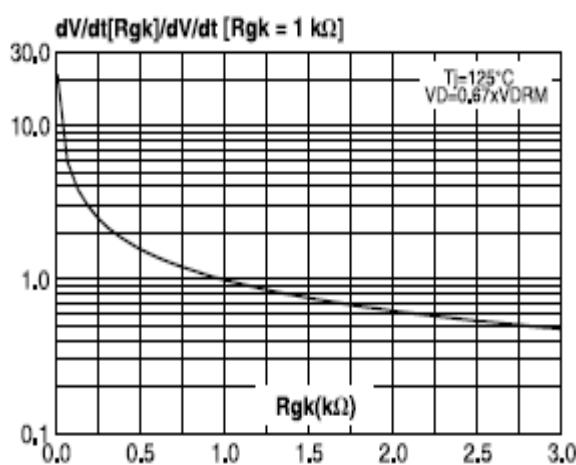


Fig.5 dv/dt VS R_{gk}

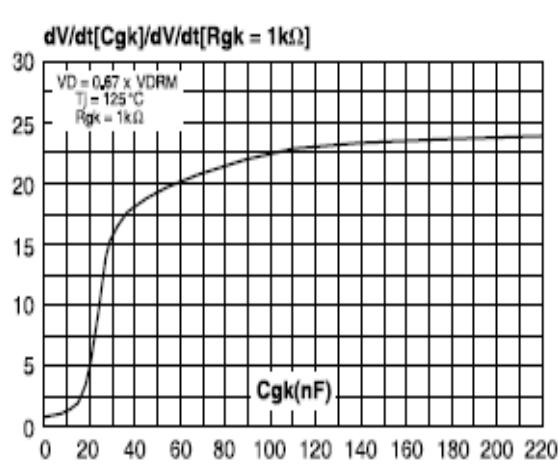


Fig.6 dv/dt VS C_{gk}

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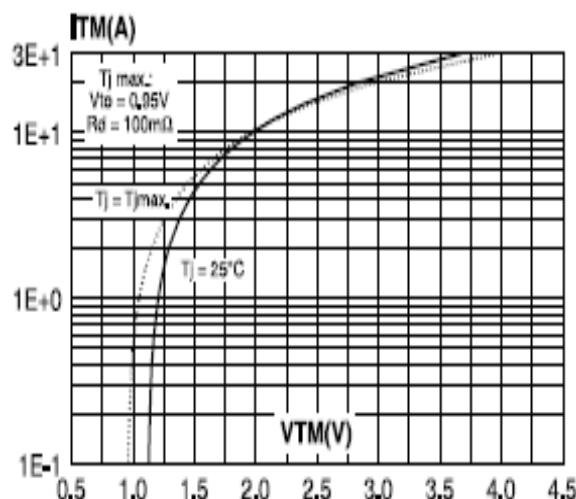


Fig.7 On-state Characteristics

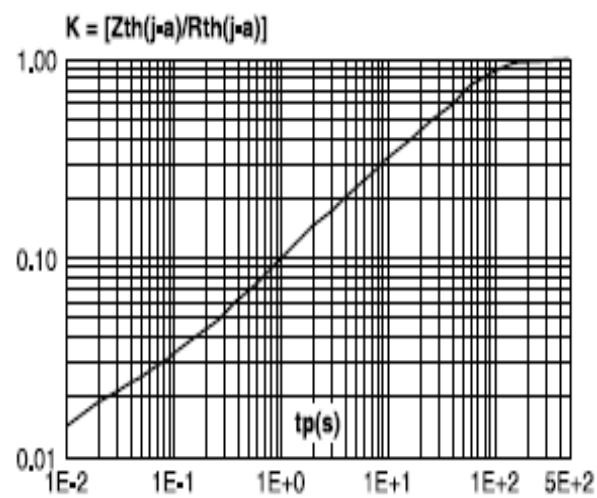


Fig.8 $R_{DS(on)}$ VS Pulse duration

TO251 Package Dimension**Unit:mm**